

# Le71HE0011 Le78D11 /Le77D11 Evaluation Board, Revision D1 User's Guide

Rev. A, Version 1 March 5, 2003

**Document Number: 081081** 

| The contents of this document are provided in connection with Legerity, Inc. products. Legerity makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this publication. Except as set forth in Legerity's Standard Terms and Conditions of Sale, Legerity assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right. |
|--|
| Legerity's products are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or in any other application in which the failure of Legerity's product could create a situation where personal injury, death, or severe property or environmental damage may occur. Legerity reserves the right to discontinue or make changes to its products at any time without notice.   |
| © 2003 Legerity, Inc. All rights reserved.   |
|  |
|  |
|  |
|  |

#### Trademarks

Legerity, the Legerity logo and combinations thereof, VoSLIC, VoSLAC, WinACIF, WinSLAC, and WinSLAC2 are trademarks of Legerity, Inc. Other product names used in this publication are for identification purposes only and may be trademarks of their respective companies.



# **TABLE OF CONTENTS**

| CHAPTER 1 | INTRODUCTION  |               |
|-----------|---|---------------|
| CHAPTER 2 | BOARD SETUP AND CONNECTION  2.1 Board Features  2.2 Board Modifications  2.2.1 BGND-to-AGND  2.2.2 Surge Protection  2.2.3 Unpopulated Components  2.3 Board Connections  2.3.1 Power  2.4 Test Points  2.5 Telephone Line Interface  2.6 Interconnection of the Le71HE0011 Evaluation Board  2.7 PCM/MPI Connections | 3 3 3 3 5 5 6 |
| CHAPTER 3 | BOARD OPERATION AND CONTROL       9         3.1 Switcher Configurations       9         3.2 Jumper Settings       9         3.2.1 JP1 and JP2       9         3.2.2 JP3       9         3.2.3 JP4       10         3.3 Component Carriers       1   | 999           |
| CHAPTER 4 | SOFTWARE OPERATION         1           4.1 Overview         1   |               |
| CHAPTER 5 | EVALUATION BOARD SCHEMATICS15.1 Evaluation Board Schematics15.2 Bill of Materials2  | 5             |



1

## INTRODUCTION



#### 1.1 OVERVIEW

The Legerity Le71HE0011 evaluation board provides a platform to evaluate the capabilities of the Le78D11 (rev. A2) and Le77D11 SLIC (rev. BAxx) devices. The evaluation board provides a flexible platform to evaluate both of the device's channels. All digital control signals and voice band signals have test points for easy probing. All user selectable components are mounted on component carriers for easy modification where required. All power is brought to the board via a single keyed connector.

Detailed device explanations, operational circuit descriptions and required formulas can be found within the individual data sheets. Figure 1–1 below shows the physical layout of the Le71HE0011 evaluation board.

RING2 DI/DO Select (JP4) Pin 1 to 2 sets DI/DO Commo Pin 2 to 3 separates DI & DO RDC2 VREF . ē TIP1 AGNO DOWN Legerity, Inc. 0 VoSLAC/VoSLIC Evaluation Board DO Active when DI & gre not common. **□**A1 OPN #: Le71HE0011 Revision: D1 Protection Ground BGND RING

Figure 1–1 Le71HE001x Evaluation Board, Rev. D1 Silk-Screen

0



Introduction 2

# 2

# **BOARD SETUP AND CONNECTION**



#### 2.1 BOARD FEATURES

The Le71HE0011 evaluation board features the following:

- Four layer board
  - Layer 1: Top routed traces
  - Layer 2: Internal voltage planes (variable 3.3 V/Fixed 3.3 V and VPOS)
  - Layer 3: Internal ground planes (DGND, AGND and BGND)
  - Layer 4: Bottom routed traces

#### 2.2 BOARD MODIFICATIONS

#### 2.2.1 BGND-to-AGND

The BGND-to-AGND connections for the PCB (printed circuit board) is made via the two jumpers located underneath the Le77D11 device socket. The jumpers keep AGND and BGND potentials to within 50 mV of each other.

#### 2.2.2 Surge Protection

The surge protector for the board is the Power Innovations<sup>®</sup> TISP61089B. The TIP/RING signals are routed through the part. The switcher junction of DSW, CFL and LVREG generates the gating signal for the Power Innovations part. This junction will typically be 8-10 volts above the ringing signal. The two "Protection Ground" banana jacks (BJ5 and BJ6) allow for the surge signal to bypass the BGND plane up to the common BGND connection at PW1. In order for BJ5 to go directly to the PW1 connector the wire jumper, located 0.125 in. to the right of the connector, must be cut and a *short* banana jack must be placed from BJ5 to BJ6.

The VA and VB sense resistors are surface mounted resistors whose values are 243 k $\Omega$  and 232 k $\Omega$ , respectively.

#### 2.2.3 Unpopulated Components

Components not loaded at assembly time are listed in Table 2–1 below.

Table 2-1 Unpopulated Components

| Component              | Reason not Loaded                           |  |  |
|------------------------|---|--|--|
| RXA1, RXB1, RXA2, RXB2 | Not required                                |  |  |
| PTC1, PTC2, PTC3, PTC4 | Board uses 50 $\Omega$ wire wound resistors |  |  |
| CVT1 and CVT2          | Not required                                |  |  |
| CFL11 and CFL22        | Not required                                |  |  |
| CIMT1 and CIMT2        | Not required                                |  |  |

The FZT953 was changed to a FZT955 due to the higher voltage rating (200 V) of the FZT955. This will facilitate 100 V ringing on the PCB.

#### 2.3 BOARD CONNECTIONS

#### 2.3.1 Power

The power cable (IAV/IAV-DOV) brings all required power to the PCB via the 10-pin header, PW1. The pin out of the cable, and a short description, is provided in Table 2–2.

#### LE71HE0011 EVALUATION BOARD REV. D1 USER'S GUIDE

Table 2-2 PW1 10-Pin Connector Power Cables

| Pin# | Signal      | Description  | Board      |  |
|------|-------------|--|------------|--|
| 1    | DGND        | Digital ground   | DGND       |  |
| 2    | + 3.3 V     | Variable V <sub>CC</sub> supply                          | VoSLAC_VCC |  |
| 3    | AUX_VCC     | Supply for 3.3 V voltage regulator and pull up resistors | AUX_VCC    |  |
| 4    | SLIC_VCC    | V <sub>CC</sub> supply for the Le77D11 device            | VoSLIC_VCC |  |
| 5    | AGND        | Analog ground  | AGND       |  |
| 6    | RING SOURCE | Not required   | N/C        |  |
| 7    | BGND        | Battery ground   | BGND       |  |
| 8    | VBP         | Positive voltage   | VSW        |  |
| 9    | VBL         | Not required N/C   |            |  |
| 10   | VBH         | Not required N/C   |            |  |

VCC power to the Le78D11 and Le77D11 devices can be applied in the following ways:

- From a single fixed/variable supply via PW1
- From separate fixed/variable supplies via PW1
- From the on-board 3.3 V regulator VR1 via AUX\_VCC
- · One device from the fixed/variable supply, the other from VR1

Two jumpers, JP1 and JP2, select how power is applied to the devices (refer to "Jumper Settings" on page 9).

The battery ground plane for the Le77D11 device can be shorted to the AGND plane under the device socket.



#### 2.4 TEST POINTS

The evaluation board contains a total of 74 test points, which are listed in the table below.

Table 2-3 Le71HE0011 Evaluation Board Test Points

| Le71HE0011 Test Points  |   |                   |                       |                   |  |  |
|-------------------------|---|-------------------|-----------------------|-------------------|--|--|
| C1 <sub>1</sub>         | C1 <sub>1</sub> C1 <sub>2</sub> NPFL                  |                   | NPFLT <sub>2</sub>    | QS <sub>1</sub>   |  |  |
| C2 <sub>1</sub>         | C2 <sub>2</sub>                                       | CFLT <sub>1</sub> | CFLT <sub>2</sub>     | QS <sub>2</sub>   |  |  |
| C3 <sub>1</sub>         | C3 <sub>2</sub>                                       | A <sub>1</sub>    | A <sub>2</sub>        | TIP <sub>1</sub>  |  |  |
| F <sub>1</sub>          | F <sub>2</sub>  | B <sub>1</sub>    | B <sub>2</sub>        | RING <sub>1</sub> |  |  |
| IMT <sub>1</sub>        | IMT <sub>2</sub>                                      | ILS <sub>1</sub>  | ILS <sub>2</sub>      | TIP <sub>2</sub>  |  |  |
| VSTRK <sub>1</sub>      | VSTRK <sub>1</sub> V2TRK <sub>2</sub> SD <sub>1</sub> |                   | SD <sub>2</sub>       | RING <sub>2</sub> |  |  |
| RDC <sub>1</sub>        | RDC <sub>1</sub> RDC <sub>2</sub> CF                  |                   | CHS2 <sub>2</sub>     |                   |  |  |
| CHCLK                   | IREF  | VREF (x3)         | VSW (x2)              |                   |  |  |
| VOUT <sub>1</sub>       | VOUT <sub>2</sub>                                     | AGND (x5)         | BGND (x6)             |                   |  |  |
| VIN <sub>1</sub>        | VIN <sub>2</sub>                                      | DGND (x4)         |                       |                   |  |  |
| PCM MPI Test Points     |   |                   |                       |                   |  |  |
| MCLK                    | DRA [DD] <sup>1</sup>                                 | RS                | INT [S2] <sup>1</sup> |                   |  |  |
| DCLK [S0] <sup>1</sup>  | DXA [DU] <sup>1</sup>                                 | CS                | FS [DCL] <sup>1</sup> |                   |  |  |
| PCLK [FSC] <sup>1</sup> | DIO [S1] <sup>2</sup>                                 | DO <sup>2</sup>   | TSCA [G] <sup>1</sup> |                   |  |  |

#### Note:

- 1. The bracketed [xx] signal names are for the GCI mode.
- 2. The PCB is designed to allow the Data In (DI) and the Data Out (DO) pins to be tied together and driven as a single line, or to be separated and driven as two independent signals via JP4. Refer to the section on Jumper Settings for a detailed explanation.

#### 2.5 TELEPHONE LINE INTERFACE

To interface the Le71HE0011 evaluation board to a telephone station set, plug the phone connector into the RJ-11 modular jack (SK1 or SK2). The TIP and RING banana jack pair (BJ1 and BJ2 or BJ3 and BJ4) are connected in parallel with the RJ-11 jack to allow the evaluation board to interface to telephony test equipment as well.

A tip/ring surge protection circuit is included on the board. The protection circuit is placed in line with the  $A_X$  and  $B_X$  leads of the Le77D11 device and sits between tip and ring resistors (RFA $_X$  and RFB $_X$ ) as they connect to the TIP/RING banana jacks. The protection device is a Power Innovations TISP61089B.

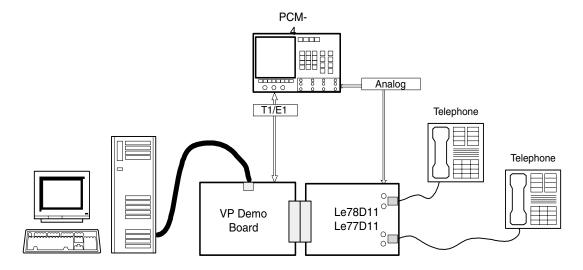


#### 2.6 INTERCONNECTION OF THE LE71HE0011 EVALUATION BOARD

A representative connection of a complete Legerity evaluation platform setup is shown in Figure 2–1 and Figure 2–2 below.

Figure 2–1 shows the evaluation board connected to the 50-pin connector (SPA) of the VP Demo board. The host PC runs the VP-Script Software. Commands are passed through the VP Demo board, via the serial connection of COM1 or COM2, to the evaluation board.

Figure 2–1 Le71HE0011 Evaluation Board Connection Diagram



Analog access to test equipment is connected to the tip/ring connectors of the Le71HE0011 evaluation board. Digital PCM access to test equipment is provided through the VP Demo Board.

Figure 2–2 shows the evaluation board connected to the 50-pin connector LNB#0 of the ACIF2-A Board. The host PC runs the WinACIF Software. Commands are passed through the ACIF2-A board, via the serial connection of COM1 or COM2, to the evaluation board.

ACIF2-A
Board

Le78D11

Le77D11

Telephone

Figure 2–2 Le71HE0011 Evaluation Board Connection Diagram
PCM-

Analog access to test equipment is connected to the tip/ring connectors of the Le71HE0011 evaluation board. Digital PCM access to test equipment is provided through the ACIF2-A board.



#### 2.7 PCM/MPI CONNECTIONS

All PCM/MPI interface signals are passed through the IFB0 connector. The three clock signals — MCLK, PCLK and DCLK — have guard band traces running along side the clock signals and are routed on the top layer of the evaluation board. All other PCM/MPI signals are routed on the bottom of the evaluation board. Table 2–4 shows the PCM/MPI connections.

Table 2-4 PCM/MPI Connections

| Pin#  | Signal | Pin#  | Signal         |
|-------|--------|-------|----------------|
| 1     | RS     | 26    | Digital Ground |
| 2     | MCLK   | 27    | Digital Ground |
| 3     | DCLK   | 28    | Digital Ground |
| 4     | N/C    | 29    | Digital Ground |
| 5     | DI/DO  | 30    | Digital Ground |
| 6     | INT    | 31    | Digital Ground |
| 7     | DXA    | 32    | Digital Ground |
| 8     | CS     | 33    | Digital Ground |
| 9     | DRA    | 34    | Digital Ground |
| 10    | N/C    | 35    | Digital Ground |
| 11    | FS     | 36    | Digital Ground |
| 12    | PCLK   | 37    | Digital Ground |
| 13-24 | N/C    | 38-50 | Digital Ground |
| 25    | DO     |       |                |

The Le71HE0011 evaluation board has separate pins for the data in (DI) and the data out (DO). A single jumper (JP4) on the PCB allows the user to either make the two signals common (DIO) or separate them. Refer to "Jumper Settings" on page 9 for specific details. Also, refer to the Le78D11 device schematic page in "Evaluation Board Schematics" on page 15 for specific pin connections to the IFB0 connector.





# 3

# **BOARD OPERATION AND CONTROL**



#### 3.1 SWITCHER CONFIGURATIONS

The Le71HE0011 evaluation board is designed to operate with a bipolar switcher configuration.

#### 3.2 JUMPER SETTINGS

#### 3.2.1 JP1 and JP2

Jumpers JP1 and JP2 configure the VoSLAC\_VCC and VoSLIC\_VCC applied to the devices to come from either an external variable power supply, via the PW1 connector, or from the on-board voltage regulator (VR1) which is powered by AUX\_VCC. Table 3–1 below details the settings.

Table 3-1 JP1 and JP2 Jumper Settings

| Jumper<br>Row | Pins | Description  |  |  |  |
|---------------|------|--|--|--|--|
| JP1           | 1-2  | Sets the Le78D11 device voltage to be supplied from the PW1 VoSLAC_VCC input |  |  |  |
| JP1           | 2-3  | Sets the Le78D11 device voltage to be supplied from the AUX_VC via VR1       |  |  |  |
| JP2           | 1-2  | Sets the Le77D11 device voltage to be supplied from the PW1 VoSLIC_VCC input |  |  |  |
| JP2           | 2-3  | Sets the Le77D11 device voltage to be supplied from AUX_VCC via VR1          |  |  |  |

#### 3.2.2 JP3

The JP3 jumper has a dual purpose depending on the mode the Le78D11 device is set to operate in. In the PCM mode, JP3 will need to be set to pull the TSCA output pin high since TSCA, in the PCM mode, is an open-drain signal that is fed back to the ACIF2-A or VP demo board. In the GCI mode, this pin becomes the G input which can be strapped High or Low via the jumper. If JP3 is set to the HIGH position on the board the G pin can be programmed via the ACIF2-A board.

Table 3-2 JP3 Jumper Settings

| Jumper<br>Row   | Pins   | Description  |  |  |  |  |
|---|--|--|--|--|--|--|
|   | PCM Mode   |  |  |  |  |  |
| JP3   | JP3 1-2 Allows the TSCA condition to be monitored via the ACIF2-A board. |  |  |  |  |  |
|   |  | GCI Mode   |  |  |  |  |
| JP3 Straps the G input HIGH (logic 1). Not applicable in the VP demo board. |  |  |  |  |  |  |
| JP3   | 2-3  | Straps the G input LOW (logic 0). Not applicable in the VP demo board. |  |  |  |  |



#### 3.2.3 JP4

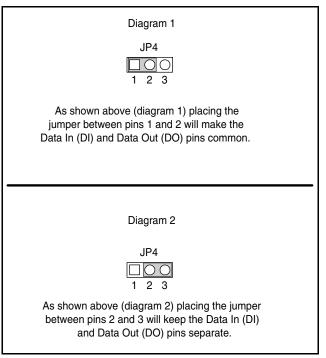
Jumper JP4 selects whether the DI and DO pins of the Le78D11 device are common to each other or are separate inputs.

Table 3-3 JP4 Jumper Settings

| Jumper<br>Row | Pins | Description   |  |  |
|---------------|------|---|--|--|
| JP4           | 1-2  | Shorts DI and DO together to allow them to be driven via a single source.                 |  |  |
| JP4           | 2-3  | Separates DI and DO to allow the pins to be driven by separate sources. (default setting) |  |  |

The DI (DATA IN) pin is connected directly to pin 5 of the IFB0 connector and to pin 1 of JP4. The DO (DATA OUT) pin is connected *only* to connected to pin 2 of JP4. The DO connection from pin 25 of the IFB0 connector is routed to JP4 pin 3. The diagram below details both settings for JP4.

Figure 3–1 JP4 Jumper Settings



When using the VP Demo Board, the setting will be diagram 2 (Data In and Data Out separate). This will set the evaluation board to be compatible with the startup configuration of the VP-Script and Mini-PBX software.

When using the ACIF2-A Board, the setting will be diagram 1 (Data In and Data Out common). This will set the evaluation board to be compatible with the startup configuration of the WinACIF software.



#### 3.3 COMPONENT CARRIERS

The Le71HE0011 evaluation board has two headers on it, RN1 and CC1. RN1 holds the resistor network that is used to improve the accuracy of the IDC, VA, VB and VBAT readings. The Le78D11 device has a register that can be programmed to use the external resistors. The reference voltage for the external resistors is VREF. The resistors are optional and not populated.

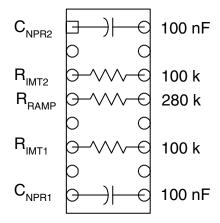
Table 3–4 details the components placed on CC1 when the Le77D11 device is configured for bipolar operation:

Table 3-4 CC1 Components

| Component                            | Description   |
|--------------------------------------|---|
| CNPR <sub>X</sub>                    | This capacitor determines the polarity reversal time.   |
| RRAMP                                | This resistor controls ramp rate for bipolar operation.   |
| RIMT <sub>X</sub> /CIMT <sub>X</sub> | This resistor and capacitor sets the 2-wire impedance ( $Z_{2WIN}$ ), 4-wire to 2-wire gain ( $G_{42}$ ) and 2-wire to 4-wire gain ( $G_{24}$ ) |

Figure 3–2 below illustrates the positioning of the components on the CC1 header. It must also be noted the 600  $\Omega$  and 900  $\Omega$  stated below are for the Le77D11 device only, not the whole board.

Figure 3–2 CC1 Component Carrier Values



The value of  $R_{\text{IMT}1}$  and  $R_{\text{IMT}2}$  will change depending on load resistance (refer to Table 3–5).

Table 3-5 R<sub>IMT1</sub> and R<sub>IMT2</sub> Resistors Values

| R <sub>LOAD</sub> | R <sub>IMT1</sub> and R <sub>IMT2</sub> Value |
|-------------------|---|
| 600 Ω             | 100 k   |
| 900 Ω             | 133 k   |



### **CHAPTER**



## **SOFTWARE OPERATION**



#### 4.1 OVERVIEW

Two control platforms allow the user to communicate with the Le71HE0011 evaluation board. The first platform is the VoicePath demo board and the VP-Script program or the VoicePath Mini-PBX software. The second platform is the ACIF2-A hardware board along with its accompanying WinACIF software program. A third software program, WinSLAC2™ software, is used to calculate the required coefficients needed by the Le77D11/Le78D11 chip set.

The WinSLAC2 software models the Le77D11/Le78D11 chip set, calculates programmable coefficients for optimizing two-wire impedance, hybrid balance and transmit and receive responses. WinSLAC2 also calculates and predicts transmission performance for:

- Two-Wire Return Loss
- Four-Wire Return Loss
- Transmit and receive attenuation distortion
- Transmit and receive path equalization
- Two-wire stability

For a more detailed description refer to the *WinSLAC2 Software User's Guide*, document ID #080779.

The VoicePath demo board is one of the control platforms that can be used for communicating with the evaluation board. The VP-Script program uses a command menu to send information to and receive information from the evaluation board (supports PCM mode only). Refer to the VP-Script Software User's Guide, document ID #080757, for more detailed information.

The ACIF2-A hardware board and the WinACIF Software are an alternate platform that can be used to communicate with the chip set. Once the software has been initialized with the correct chip set configuration, a command menu is used to send information to and receive information from the Le77D11/Le78D11 chip set (supports PCM and GCI modes). Refer to the *WinACIF User's Guide*, document ID #080269, for more detailed information.



# **CHAPTER**

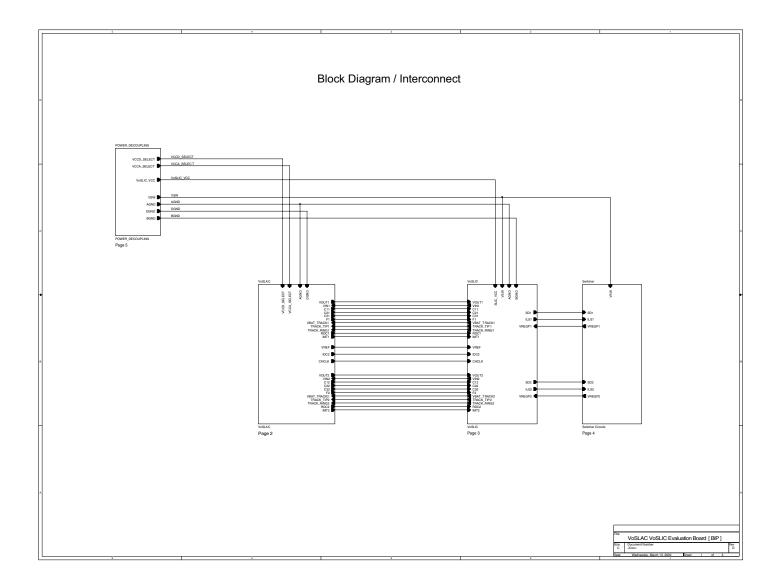
# 5 EVALUATION BOARD SCHEMATICS



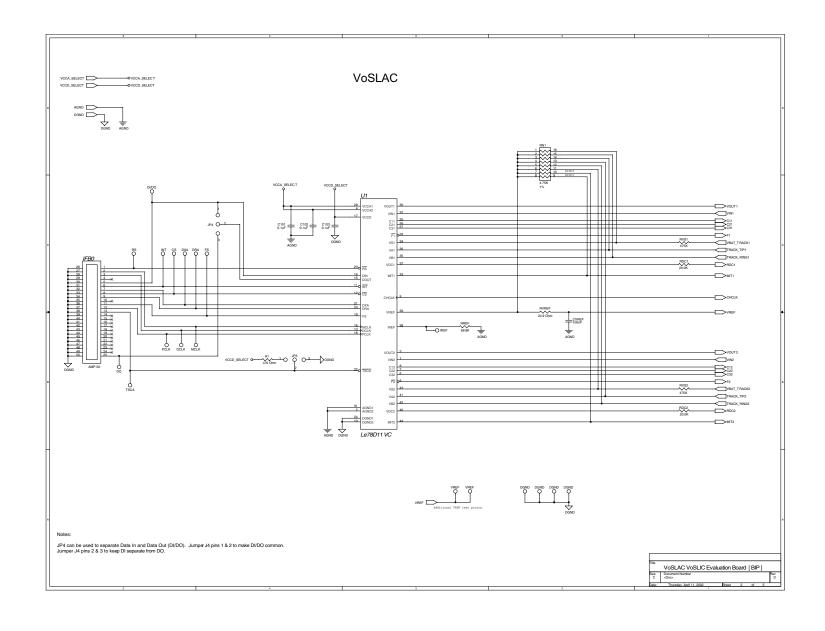
## 5.1 EVALUATION BOARD SCHEMATICS

A bill of materials and schematic for the Le77D11/Le78D11 bipolar configuration are included on the following pages.

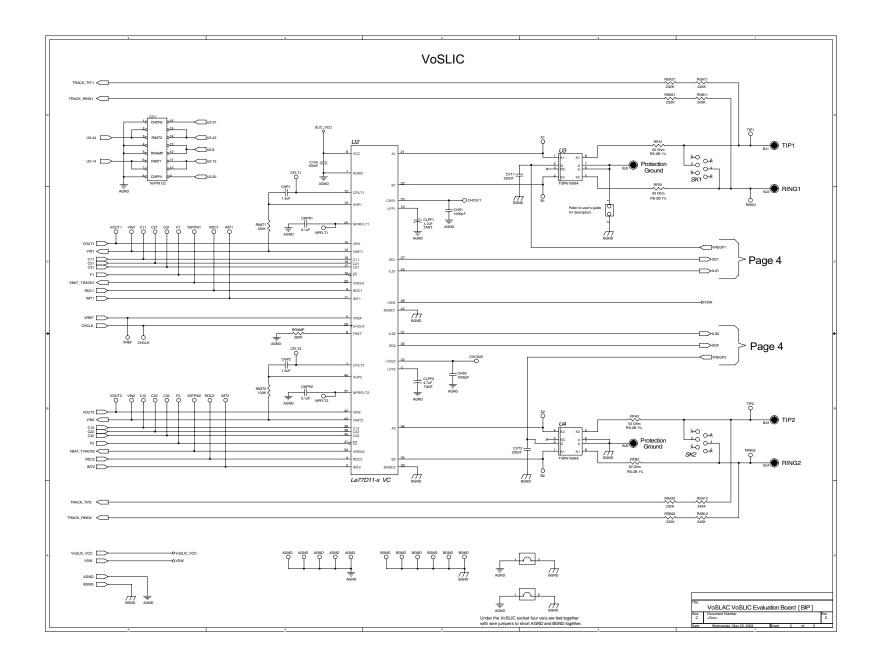




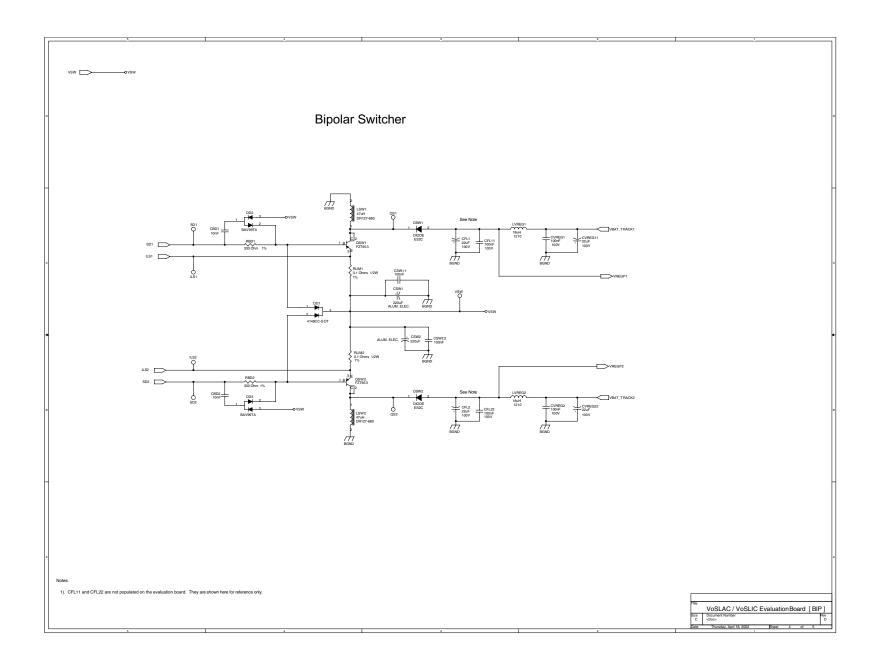




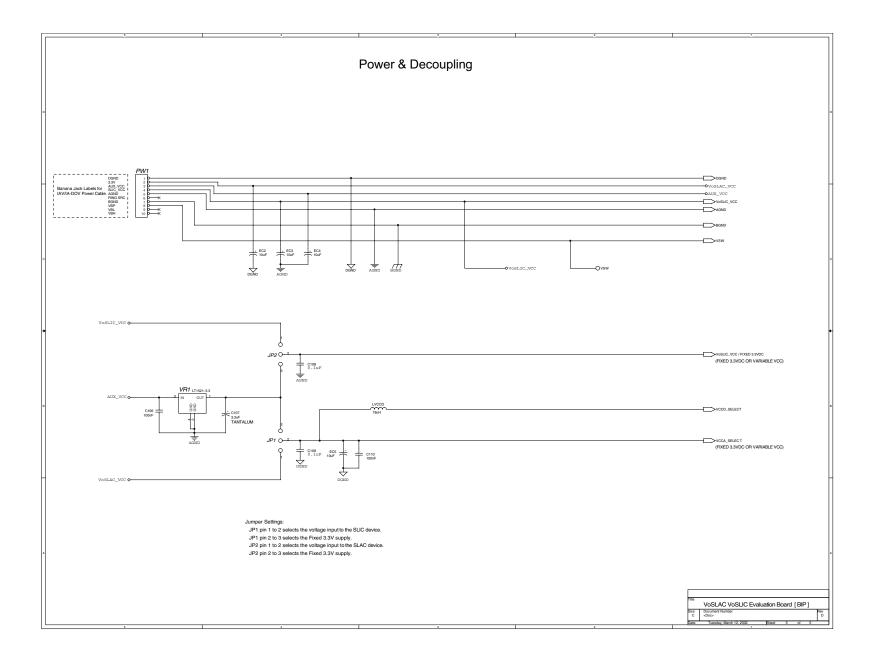














## 5.2 BILL OF MATERIALS

#### VoB Bipolar Evaluation Board Revision: D1

| Part Type                           | SM Size /    | Voltage / Tol.           | SM / TH  | Qty | Designation   | Vendor / Part Number  |
|-------------------------------------|--------------|--------------------------|----------|-----|---|---|
|                                     | TH Spacing   | Voltage / Tol.           | 3M / III | uty | Designation   | Vendor / Part Rumber  |
| Capacitors 1nF Ceramic              | 0805         | 50V / 10%                | SM       | 2   | CHS1, CHS2  | Panasonic / ECJ-2VC1H102J   |
| 10nF Ceramic                        | 1206         | 16V / 10%                | SM       | 2   | CBD1, CBD2  | Panasonic / ECJ-3VC1C103K   |
| 100nF Ceramic                       | 0805         | 16V / 10%                | SM       | 9   | C101, C102, C103, C104, C106, C108, C109, C110, CSW11, CSW22, CVREF   | Panasonic / ECJ-1VC1C104K   |
| 100nF Ceramic                       | 1210         | 100V / 10%               | SM       | 2   | CFL11, CFL22  | DO NOT POPULATE (Nova Cap / 1206B104J101N)                              |
| 1.5uF Ceramic                       | 1210<br>0805 | 100V / 10%<br>6.3V / 10% | SM<br>SM | 2   | CVREG1, CVREG2<br>CHP1, CHP2  | Kemet / C1210C104K1RAC Panasonic / ECJ-2YB0J155K (DIGI-KEY / PCC1921CT- |
|                                     |              |                          |          |     |   | ND)   |
| 3.3uF Tantalum<br>4.7uF Tantalum    | 3528<br>3216 | 16V / 10%<br>10V / 10%   | SM<br>SM | 2   | C107<br>CLPF1, CLPF2  | Kemet / T491B335K016AS<br>Kemet / T491A475K010AS                        |
| 10uF Tantalum                       | 3528         | 16V / 10%                | SM       | 4   | EC2, EC3, EC4, EC5  | Kemet / T491B106K016AS  |
| 22uF Alum. Elect.                   | 0.1"         | 100V / 10%               | TH       | 4   | CFL1, CFL2, CVREG11, CVREG22  | Panasonic / EEUFC2A220 (DIGI-KEY / P10770-ND)                           |
| 220uF Alum. Elect.                  | 0.2"         | 50V / 20%                | TH       | 2   | CSW1, CSW2  | Nichicon / UPW1H221MPH  |
| Transistors                         |              |                          |          |     |   |   |
| FZT955 200V PNP                     | SOT223       | 200V                     | SM       | 2   | QSW1, QSW2  | Zetex / FZT955  |
| Diodes                              |              | I                        |          |     |   |   |
| ES2C                                | DO-214AA     |                          | SM       | 2   | DSW1, DSW2  | General Semi. / ES2C DIODES inc. ES2C/A                                 |
| 4148-SOT                            | SOT23        |                          | SM       | 1   | DD1   | Fairchild / MMBD4148CC  |
| BAV99TA                             | SOT23        |                          | SM       | 2   | DD2, DD3  | Zetex / BAV99TA (DIGI-KEY # BAV99ZXTR-ND)                               |
| Inductor                            |              | I                        |          |     |   |   |
| 47uH                                |              |                          | SM       | 2   | LSW1, LSW2  | Cooper Coiltronics / DR127-470 or                                       |
| 18uH                                | 1210         |                          | SM       | 3   | LVREG1, LVREG2, LVCCD   | COEV / DQ1280-470 Panasonic / ELJ-PA180KF (DIGI-KEY # PCD1487CT-ND)     |
| rodi i                              | 1210         |                          | SIVI     | 3   | LVILLO I, LVILLUZ, LVOOD  | T GROSSING / ELG-I ATOURT (DIGI-NET # POD 140/CT-ND)                    |
| PTC                                 |              |                          |          |     | Inter process   |   |
| MZ2                                 |              |                          | TH       | 4   | PTC1, PTC2, PTC3, PTC4  | Do Not Populate   |
| Resistors                           |              | <u>l</u>                 |          |     |   |   |
| 0.1 Ohm                             | 1210         |                          | SM       | 2   | RLIM1, RLIM2  | Vishay / CRCW1210R100JNTALR (SAP #) (Arrow 231-                         |
|                                     |              |                          |          |     |   | 5433)   |
| 0.0 Ohm<br>50 Ohm 1% RS-2B          | 1206<br>TH   |                          | SM       | 1   | RVREF   | DIGI-KEY / 311-0.0ECT-ND  |
| 330 Ohm 1%                          | 1210         |                          | TH<br>SM | 2   | RFA1, RFB1, RFA2, RFB2<br>RBD1, RBD2  | Vishay / RS-2B-50-1% [Newark / 02F1195]<br>Vishay / CRCW1210P330F25RT6  |
| 470 Ohm 1%                          | 1206         |                          | SM       | 1   | R1  | DIGI-KEY P470ECT-ND   |
| 20.0K 1%                            | 1206         |                          | SM       | 2   | RDC1, RDC2  | DIGI-KEY / P20.0KFCT-ND   |
| 69.8K 1%                            | 1206         |                          | SM       | 1   | RREF  | DIGI-KEY / P69.8KFCT-ND   |
| 232K 1%                             | 1206         |                          | SM       | 4   | RSA21, RSB21, RSA22, RSB22  | DIGI-KEY / P232KFCT-ND  |
| 243K 1%<br>475K 1%                  | 1206<br>1206 |                          | SM<br>SM | 2   | RSA11, RSB11, RSA12, RSB12<br>RVS1, RVS2  | DIGI-KEY / P243KFCT-ND<br>DIGI-KEY / P475KFCT-ND                        |
| 11010 170                           | 1200         |                          | 0        |     | 1,1101,11102  | BIGINETY WORLD'THE  |
| Component Carrier Parts             |              |                          |          |     |   |   |
| 100nF Ceramic                       | 0.2"         | 50V / 10%                | TH       | 2   | CNPR1, CNPR2 (See attached diagram.)  | Kemet / C320C104K5R5CA  |
| 4.75K 1% 1/4W                       | TH           |                          | TH       |     | RN1 thru RN8 (See attached diagram.)  | Do Not Populate   |
| 100K 1% 1/4W                        | TH           |                          | TH       | 2   | RIMT1, RIMT2 (See attached diagram.)  | DIGI-KEY / 100KXBK-ND   |
| 280K 1% 1/4W                        | TH           |                          | TH       | 1   | RRAMP (See attached diagram.)   | DIGI-KEY / 280KXBK-ND   |
| 106                                 |              |                          |          |     |   |   |
| Le78D11 VC (VoSLAC)                 | 44 TQFP      | l                        | SM       | 1   | U1  | Legerity will provide these   |
|                                     | 44 TQFP      |                          |          |     |   |   |
| Le77D11-x VC (VoSLIC)               | EPADD        |                          | SM       | 1   | U2  | Legerity will provide these   |
| LT1521-3.3                          | SOIC         |                          | SM       | 1   | VR1   | Marshall / LT1521CST-3.3 (Linear Technologies)                          |
| TISP61089B                          | SOIC         |                          | SM       | 2   | U3, U4  | Power Innovations / TISP61089B  |
| Sockets                             |              |                          | l l      |     |   |   |
| 44-pin TQFP                         |              |                          | TH       | 2   | U1, U2  | Yamaichi / QFP11T044-001  |
| 16-pin DIP                          |              |                          | TH       | 2   | CC1, RN1  | Samtec / ICO-316-NTT  |
| Connectors                          |              | ı                        |          |     | L   |   |
| AMP Champ 50-pin                    |              |                          | TH       | 1   | IFB0  | Newark / 90F4961 [AMP 552726-1]   |
| AMP 10-pin header                   |              |                          | TH       | 1   | PW1   | Newark / 52F3052 [AMP 207398-1]   |
| Banana Jack Red                     |              |                          | TH       | 2   | BJ1, BJ3  | Newark / 39N868<br>Newark / 39N870                                      |
| Banana Jack Green Banana Jack Black |              |                          | TH<br>TH | 2   | BJ2, BJ4<br>BJ5, BJ6  | Newark / 39N869   |
| Dariaria Jack Diack                 |              |                          | - 111    |     | RS, DI/DO, INT, CS, DXA, DRA, FS,   | Newark / 3314003  |
|                                     |              |                          |          |     | PCLK, DCLK, MCLK, TSCA, IREF,<br>CHCLK, VOUT1, VIN1, C11, C21, C31,<br>F1, VBTRK1, RDC1, IMT1, CFLT1,<br>NPFLT1, VREF (x3), CFLT2, NPFLT2,  |   |
| Test Points                         |              |                          | TH       | 72  | VOUT2, VIN2, C12, C22, C32, F2, VBTRK2, RDC2, IMT2, CHS11, A1, B1, TIP1, RING1, QS1, SD1, ILS1, VSW(x2), ILS2, QS2, SD2, CHS22, A2, B2, TIP2, RING2, AGND(x5), BGND(x6), DGND(x4), DO | Mouser / 151-205  |
| 16-pin Component Carriers           |              |                          | TH       | 2   | CC1, RN1  | Samtec / APO-316-T-C or APA-316-T-C                                     |
| 6-pin RJ11                          |              |                          | TH       | 2   | SK1, SK2  | Newark / 87N981   |
| 1x3 Jumper                          |              |                          | TH       | 4   | JP1, JP2, JP3, JP4  | Legerity will provide these   |
| 2 position shunt                    |              |                          |          | 4   | N/A   | Samtec / SNT-100-YW-T   |
| Hardware                            |              | <u> </u>                 |          |     |   |   |
| 3/4" Nylon standoff 4/40            |              |                          | TH       | 8   | N/A   | Newark / 30F1466  |
| 3/8" machine screw 4-40             |              |                          | TH       | 12  | N/A   | Newark / 30F082   |
| 4-40 Nylon nut 4/40 thread          |              |                          | TH       | 4   | N/A   | Newark / 50N5869  |



4509 Freidrich Lane Austin, Texas 78744-1812

Telephone: (512) 228-5400

Fax: (512) 228-5508

North America Toll Free: (800) 432-4009

To find the Legerity Sales Office nearest you, visit our website at:

http://www.legerity.com/sales

or email:

sales@legerity.com

To download or order data sheets, application notes, or evaluation tools, go to:

www.legerity.com/support

For all other technical inquiries, please contact Legerity Tech Support at:

techsupport@legerity.com

or call +1 512.228.5400.